

UNBUMPED LOW CAPACITANCE FLIP CHIP ARRAY

APPLICATIONS

- ✓ Cellular Phones
- ✓ Personal Digital Assistant (PDA)
- ✓ Notebook Computers
- ✓ SMART Cards

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns

FEATURES

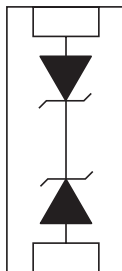
- ✓ ESD Protection > 25 kilovolts
- ✓ Available in Six Voltage Types Ranging From 3.3V to 24V
- ✓ 200 Watts Peak Pulse Power per Line ($t_p = 8/20\mu s$)
- ✓ Low Clamping Voltage
- ✓ Bidirectional Configuration & Monolithic Structure
- ✓ Protects 1 Line
- ✓ **LOW CAPACITANCE**
- ✓ **LOW LEAKAGE CURRENT**

MECHANICAL CHARACTERISTICS

- ✓ Standard EIA Chip Size: 0402
- ✓ Weight 0.73 milligrams (Approximate)
- ✓ Flammability Rating UL 94V-0
- ✓ 8mm Plastic & Paper Tape and Reel Per EIA Standard 481
- ✓ Device Marking On Reel



PIN CONFIGURATION



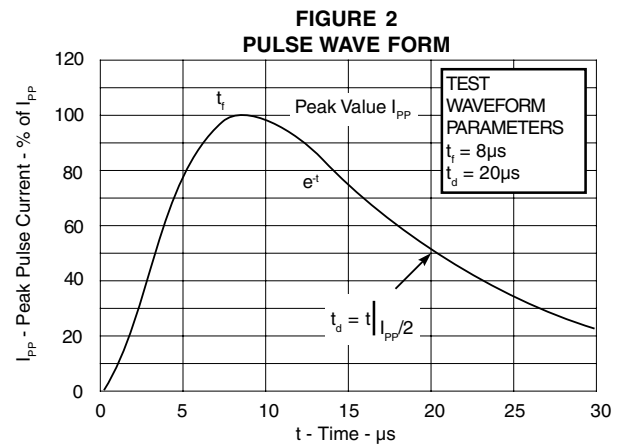
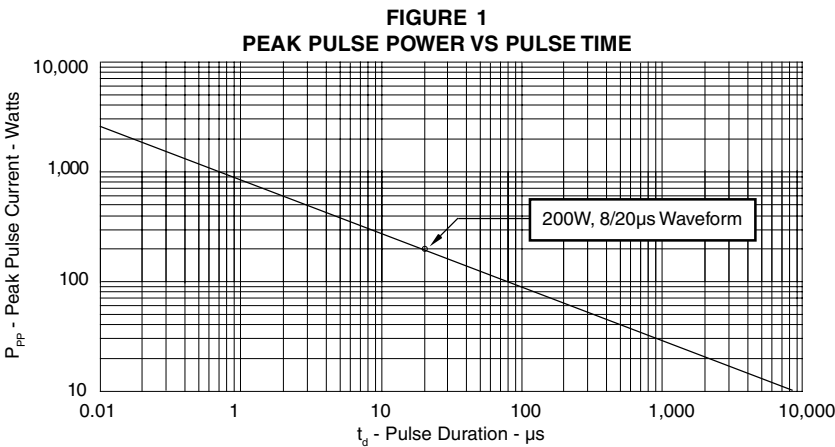
DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified			
PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ($t_p = 8/20\mu s$) - See Figure 1	P_{PP}	200	Watts
Operating Temperature	T_J	-55°C to 150°C	°C
Storage Temperature	T_{STG}	-55°C to 150°C	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified						
PART NUMBER (See Note 1)	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ $I_p = 1A$ V_C VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ 8/20 μs $V_C @ I_{PP}$	MAXIMUM LEAKAGE CURRENT (See Note 2) @ V_{WM} I_D μA	TYPICAL CAPACITANCE
						@ 0V, 1 MHz C pF
ULC0402FC3.3C	3.3	4.0	7.0	12.5V @ 16A	75*	70
ULC0402FC05C	5.9	6.0	11.0	13V @ 15A	10**	35
ULC0402FC08C	8.0	8.5	13.2	18V @ 11A	1	32
ULC0402FC12C	12.0	13.3	19.8	26.9V @ 7.4A	1	30
ULC0402FC15C	15.0	16.7	25.4	34.5V @ 5.8A	1	25
ULC0402FC24C	24.0	26.7	37.2	50.6V @ 4A	1	20

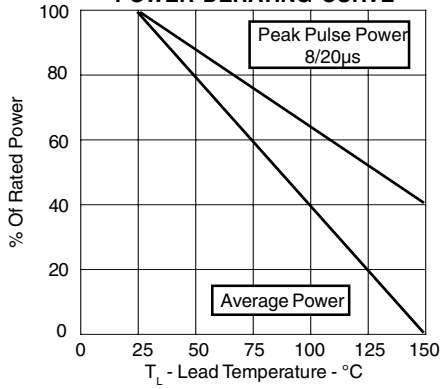
Note 1: All devices are bidirectional. Electrical characteristics apply in both directions.

Note 2: *Maximum leakage current < 5 μA @ 2.8V. **Maximum leakage current < 500nA @ 3.3V.

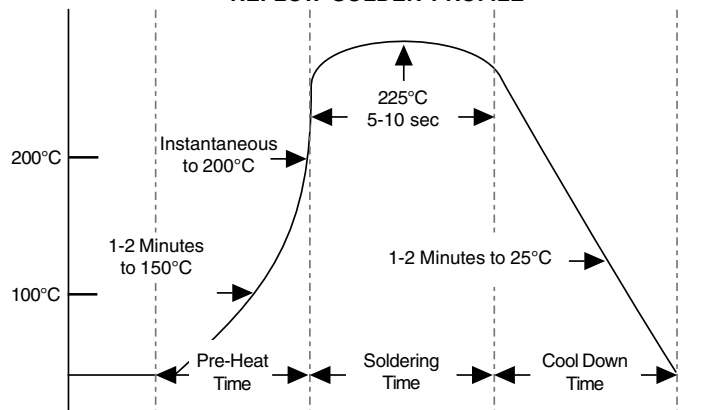


GRAPHS

**FIGURE 3
 POWER DERATING CURVE**

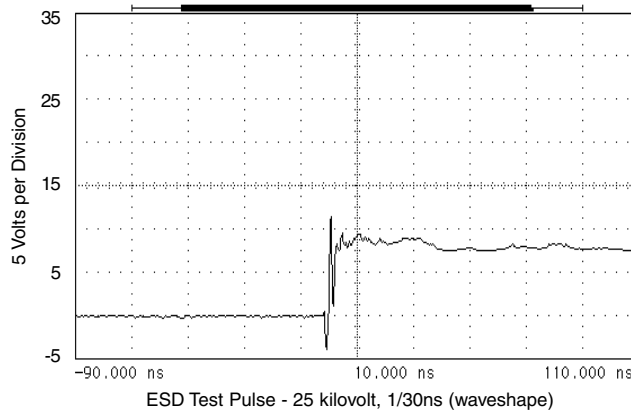


**FIGURE 4
 REFLOW SOLDER PROFILE**

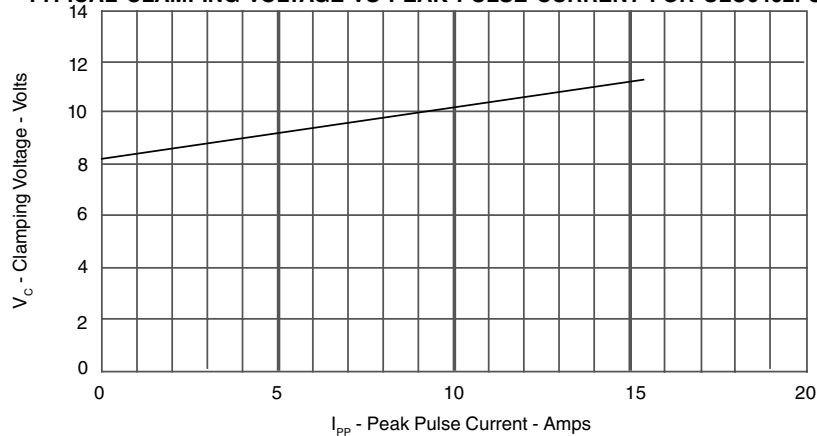


Note: This reflow profile does not take into account the printed circuit board (PCB) material heating time. Additional time may be required for the preheat time and cool down time upon the PCB or board material.

**FIGURE 5
 OVERSHOOT & CLAMPING VOLTAGE FOR ULC0402FC05C**



**FIGURE 6
 TYPICAL CLAMPING VOLTAGE VS PEAK PULSE CURRENT FOR ULC0402FC05C**



PACKAGE OUTLINE & DIMENSIONS

PACKAGE OUTLINE		U0402		
				PACKAGE DIMENSIONS
DIM	MILLIMETERS	INCHES		
A	0.46 NOM	0.018 NOM		
B	0.86 NOM	0.034 NOM		
C	0.99 ± 0.0254	0.039 ± 0.001		
D	0.10 NOM	0.004 NOM		
E	0.35 NOM	0.014 NOM		
F	0.483 ± 0.0254	0.019 ± 0.001		
I	0.406 NOM	0.016 NOM		
NOTES: 1. Controlling dimensions in inches. 2. Decimal tolerances for mounting pad and outline: .xxx ± 0.05mm (± 0.002"). 3. Maximum chip size: 1.02 (0.040") by 0.51(0.020").				
MOUNTING PAD		PAD DIMENSIONS		
		DIM	MILLIMETERS	INCHES
		A	0.23	0.009
B	0.48	0.019		
C	0.69	0.027		
D	0.46	0.018		
E	0.99	0.039		
F	0.20	0.008		
G	0.20	0.008		
H	0.66	0.026		
I	0.13	0.005		
NOTE: 1. Top view of tape. Metal contacts are face down in tape package.				
TAPE & REEL ORIENTATION				
NOTE: 1. Preferred: Using 0.1 mm (0.004") stencil.				
Outline & Dimensions: Rev 3 - 11/02, 06020				
TAPE & REEL ORDERING NOMENCLATURE 1. Surface mount product is taped and reeled in accordance with EIA 481. 2. 8mm Plastic Tape: 7 Inch Reels - 5,000 pieces per reel. Ordering Suffix: -T75-1 (i.e., ULC0402FC05C-T75-1). 3. 8mm Paper Tape: 7 Inch Reels - 10,000 pieces per reel. Ordering Suffix: -T710-2 (i.e., ULC0402FC05C-T710-2).				

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